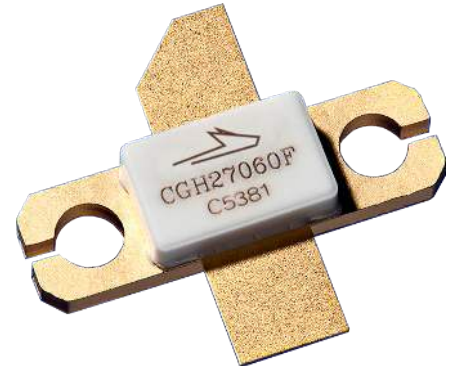


# CGH27060F

60 W Peak, 28 V, GaN HEMT for Linear Communications from VHF to 3 GHz

## Description

WolfSpeed's CGH27060F is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically for high efficiency, high gain and wide bandwidth capabilities, which makes the CGH27060F ideal for VHF, Comms, 3G, 4G, LTE, 2.3-2.9GHz WiMAX and BWA amplifier applications. The unmatched transistor is supplied in a ceramic/metal flange package.



Package Types: 440193  
PN: CGH27060F

## Typical Performance Over 2.3-2.7 GHz ( $T_c = 25^\circ\text{C}$ ) of Demonstration Amplifier

Parameter	2.3 GHz	2.4 GHz	2.5 GHz	2.6 GHz	2.7 GHz	Units
Small Signal Gain	15.1	14.7	14.3	14.3	14.5	dB
EVM @ 39 dBm	2.35	2.16	2.01	2.13	2.82	%
Drain Efficiency @ 39 dBm	28.3	27.6	27.3	26.7	26.3	%
Input Return Loss	10.0	7.3	6.0	7.0	10.3	dB

### Note:

Measured in the CGH27060F-AMP amplifier circuit, under 802.16 OFDM, 3.5 MHz Channel BW, 1/4 Cyclic Prefix, 64 QAM Modulated Burst, 5ms Burst, Symbol Length of 59, Coding Type RS-CC, Coding Rate Type 2/3, PAR = 9.8 dB @ 0.01% Probability on CCDF

## Features

- VHF - 3.0 GHz Operation
- 14 dB Small Signal Gain
- 8.0 W  $P_{AVE}$  at < 2.0% EVM
- 27% Drain Efficiency at 8 W Average Power
- WiMAX Fixed Access 802.16-2004 OFDM
- WiMAX Mobile Access 802.16e OFDMA

 Large Signal Models Available for ADS and MWO





## Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	$V_{DS}$	120	V	25°C
Gate-to-Source Voltage	$V_{GS}$	-10, +2		
Storage Temperature	$T_{STG}$	-65, +150	°C	
Operating Junction Temperature	$T_J$	225		
Maximum Forward Gate Current	$I_{GMAX}$	15	mA	25°C
Maximum Drain Current <sup>1</sup>	$I_{DMAX}$	6	A	
Soldering Temperature <sup>2</sup>	$T_S$	245	°C	
Screw Torque	$\tau$	40	in-oz	
Thermal Resistance, Junction to Case <sup>3</sup>	$R_{\theta JC}$	2.8	°C/W	85°C
Case Operating Temperature <sup>3</sup>	$T_C$	-40, +150	°C	

Notes:

<sup>1</sup> Current limit for long term, reliable operation

<sup>2</sup> Refer to the Application Note on soldering at [wolfspeed.com/rf/document-library](http://wolfspeed.com/rf/document-library)

<sup>3</sup> Measured for the CGH27060F at  $P_{DISS} = 56$  W.

## Electrical Characteristics ( $T_c = 25^\circ\text{C}$ )

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>DC Characteristics<sup>1</sup></b>						
Gate Threshold Voltage	$V_{GS(th)}$	-3.5	-3.0	-2.0	$V_{DC}$	$V_{DS} = 10$ V, $I_D = 14.4$ mA
Gate Quiescent Voltage	$V_{GS(Q)}$	–	-2.7	–		$V_{DS} = 28$ V, $I_{DQ} = 300$ mA
Saturated Drain Current	$I_{DS}$	11.6	14.0	–	A	$V_{DS} = 6.0$ V, $V_{GS} = 2$ V
Drain-Source Breakdown Voltage	$V_{BR}$	84	–	–	$V_{DC}$	$V_{GS} = -8$ V, $I_D = 14.4$ mA
<b>RF Characteristics<sup>2,3</sup> (<math>T_c = 25^\circ\text{C}</math>, <math>F_0 = 2.5</math> GHz unless otherwise noted)</b>						
Small Signal Gain	$G_{SS}$	11.0	13.0	–	dB	$V_{DD} = 28$ V, $I_{DQ} = 300$ mA
Drain Efficiency <sup>4</sup>	$\eta$	21	24	–	%	$V_{DD} = 28$ V, $I_{DQ} = 300$ mA, $P_{AVE} = 8$ W
Error Vector Magnitude	EVM	–	2.0	–		
Output Mismatch Stress	VSWR	–	–	10:1	$\Psi$	No damage at all phase angles, $V_{DD} = 28$ V, $I_{DQ} = 300$ mA, $P_{AVE} = 8$ W
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{GS}$	–	19.0	–	pF	$V_{DS} = 28$ V, $V_{GS} = -8$ V, $f = 1$ MHz
Output Capacitance	$C_{DS}$	–	5.9	–		
Feedback Capacitance	$C_{GD}$	–	0.8	–		

Notes:

<sup>1</sup> Measured on wafer prior to packaging.

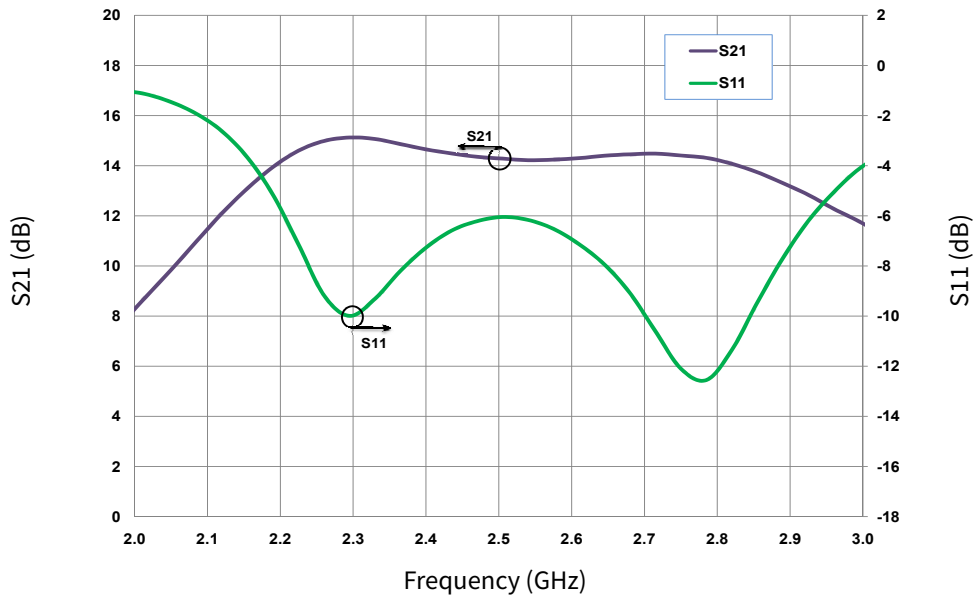
<sup>2</sup> Measured in the CGH27060F-AMP test fixture

<sup>3</sup> Under 802.16 OFDM, 3.5 MHz Channel BW, 1/4 Cyclic Prefix, 64 QAM Modulated Burst, 5ms Burst, Symbol Length of 59, Coding Type RS-CC, Coding Rate Type 2/3, PAR = 9.8 dB @ 0.01% Probability on CCDF

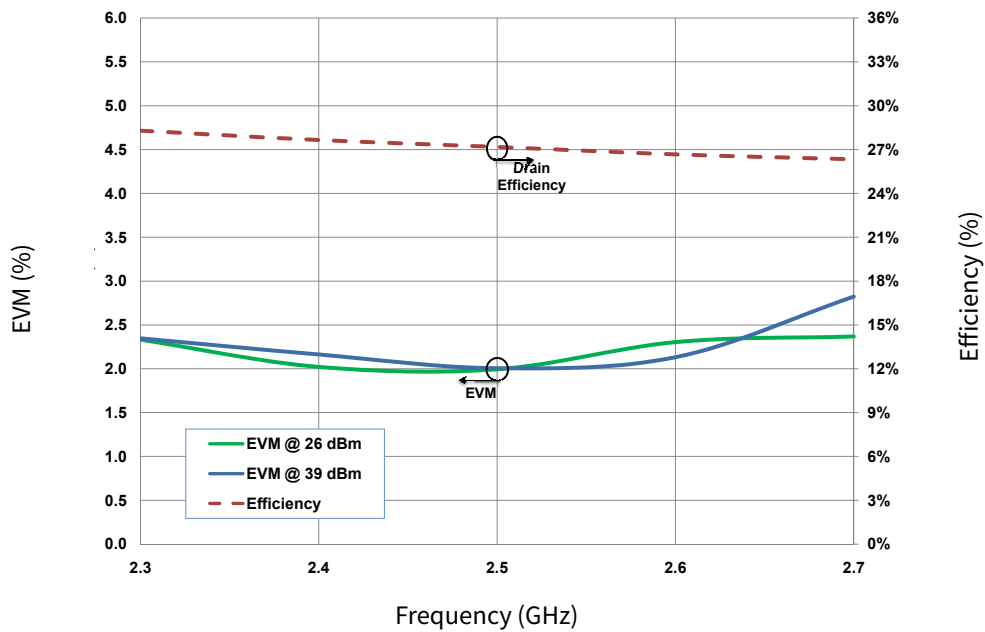
<sup>4</sup> Drain Efficiency =  $P_{OUT} / P_{DC}$



**Typical WiMAX Performance**



**Figure 1.** Gain and Return Loss vs Frequency measured in Broadband Amplifier Circuit CGH27060F-AMP  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 300\text{ mA}$

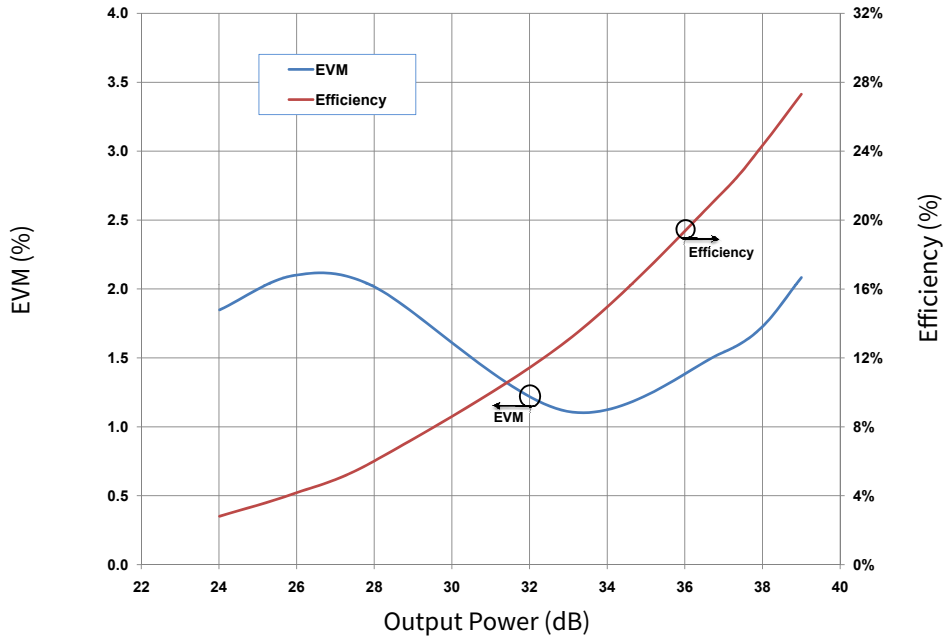


**Figure 2.** Typical EVM at 24 dBm and 39 dBm vs Frequency measured in Broadband Amplifier Circuit CGH27060F-AMP

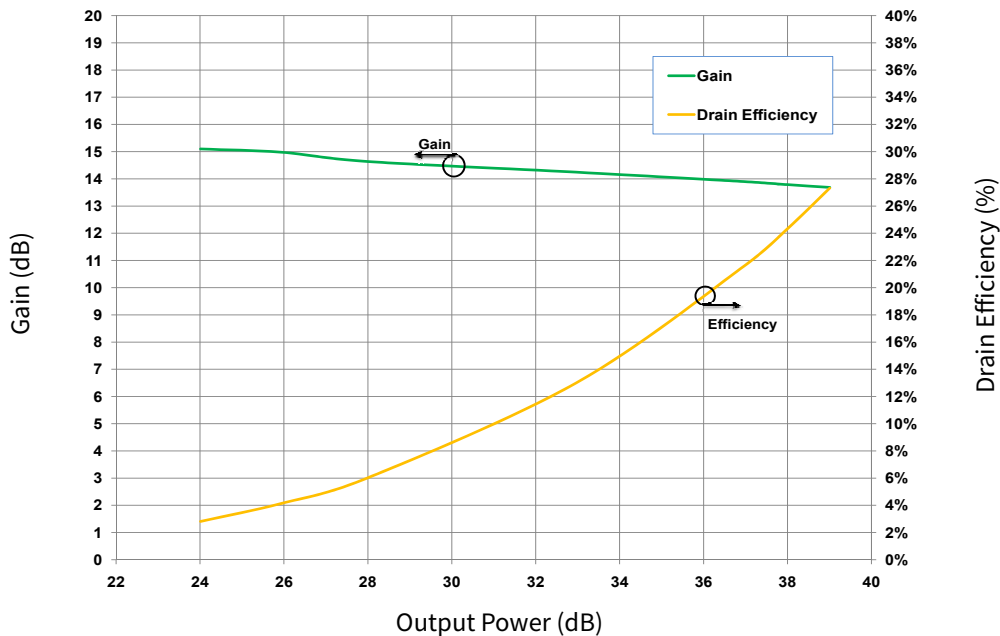
Note:  
<sup>1</sup> Under 802.16-2004 OFDM, 3.5 MHz Channel BW, 1/4 Cyclic Prefix, 64 QAM Modulated Burst, Symbol Length of 59, Coding Type RS-CC, Coding Rate Type 2/3.



Typical WiMAX Performance



**Figure 3.** Drain Efficiency and EVM vs Output Power measured in CGH27060F-AMP  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 300\text{ mA}$ , 802.16-2004 OFDM, PAR = 9.8 dB

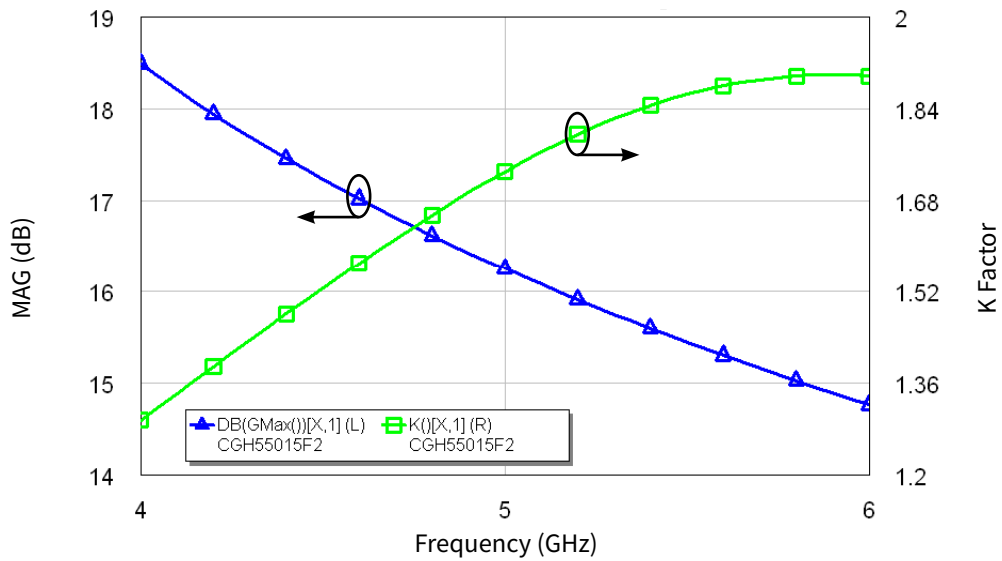


**Figure 4.** Typical Gain and Efficiency vs Output Power measured in CGH27060F-AMP  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 300\text{ mA}$ , 802.16-2004 OFDM, PAR = 9.8 dB

Note:  
<sup>1</sup> Under 802.16-2004 OFDM, 3.5 MHz Channel BW, 1/4 Cyclic Prefix, 64 QAM Modulated Burst, Symbol Length of 59, Coding Type RS-CC, Coding Rate Type 2/3.

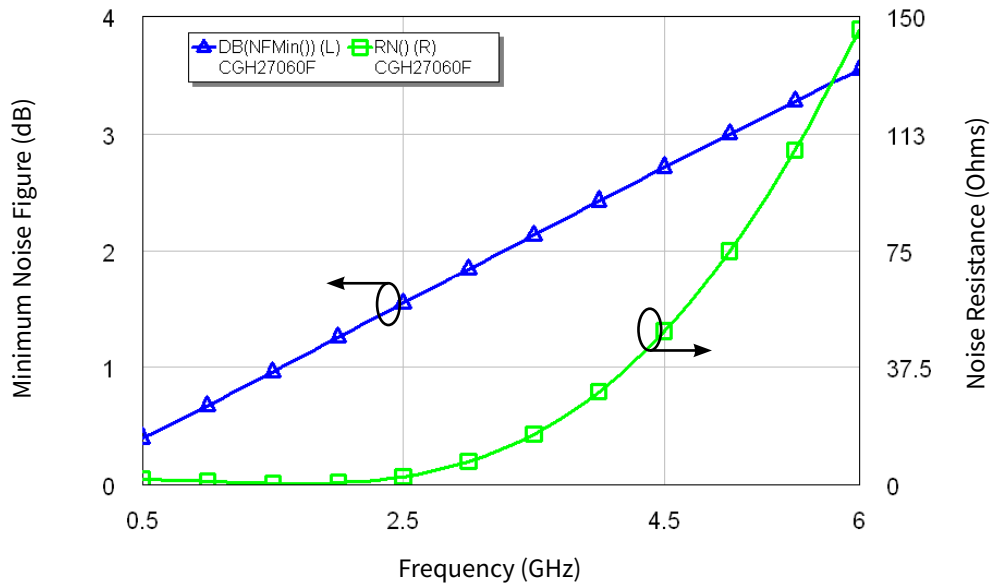


**Typical Performance**



**Figure 5.** Simulated Maximum Available Gain and K Factor of the CGH27060F  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 300\text{ mA}$

**Typical Noise Performance**



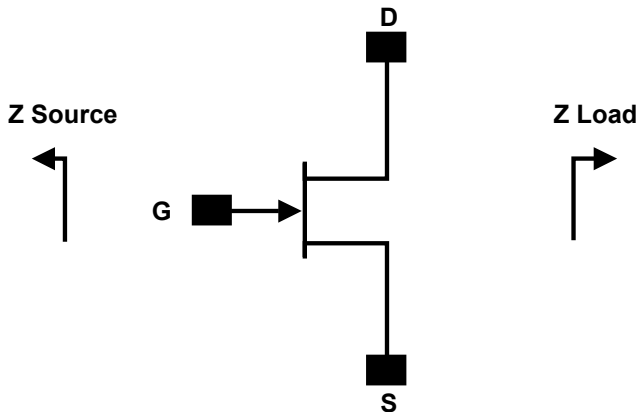
**Figure 6.** Simulated Minimum Noise Figure and Noise Resistance vs Frequency of the CGH27060  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 100\text{ mA}$

**Electrostatic Discharge (ESD) Classifications**

Parameter	Symbol	Class	Classification Level	Test Methodology
Human Body Model	HBM	TBD	ANSI/ESDA/JEDEC JS-001 Table 3	JEDEC JESD22 A114-D
Charge Device Model	CDM	TBD	ANSI/ESDA/JEDEC JS-002 Table 3	JEDEC JESD22 C101-C



### Source and Load Impedances



Frequency	Z Source	Z Lead
500	$3.34 + j4.56$	$10.8 - j8.24$
1000	$2.07 - j0.05$	$6.18 - j4.17$
2000	$1.3 - j3.37$	$4.65 - j0.05$
3000	$1.64 - j8.15$	$4.75 - j3.4$
4000	$1.9 - j10.8$	$4.56 - j7.9$

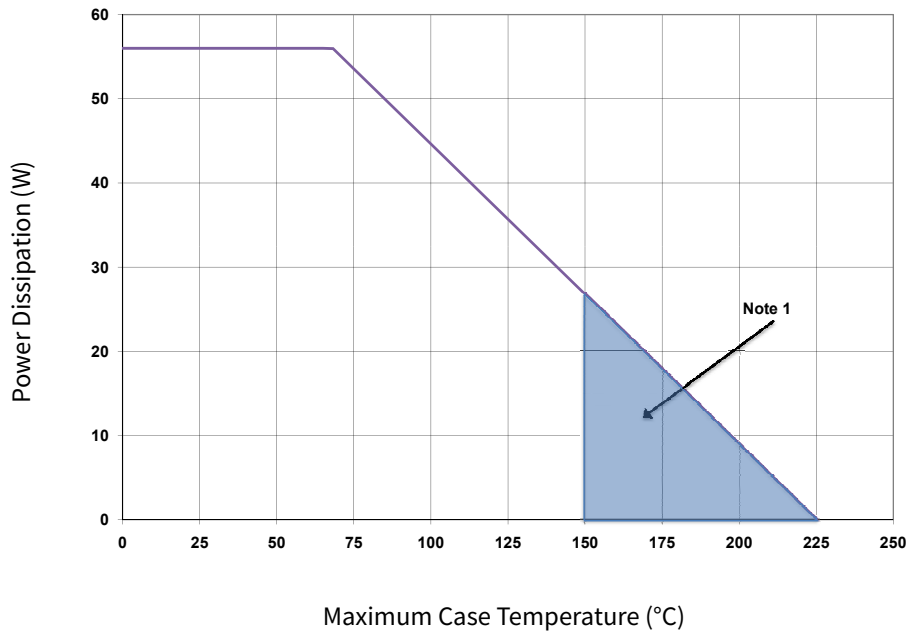
Notes:

<sup>1</sup>  $V_{DD} = 28V, I_{DQ} = 300mA$  in the 440193 package

<sup>2</sup> Optimized for  $P_{SAT}$  and PAE

<sup>3</sup> When using this device at low frequency, series resistors should be used to maintain amplifier stability

### CGH27060F Power Dissipation De-rating Curve



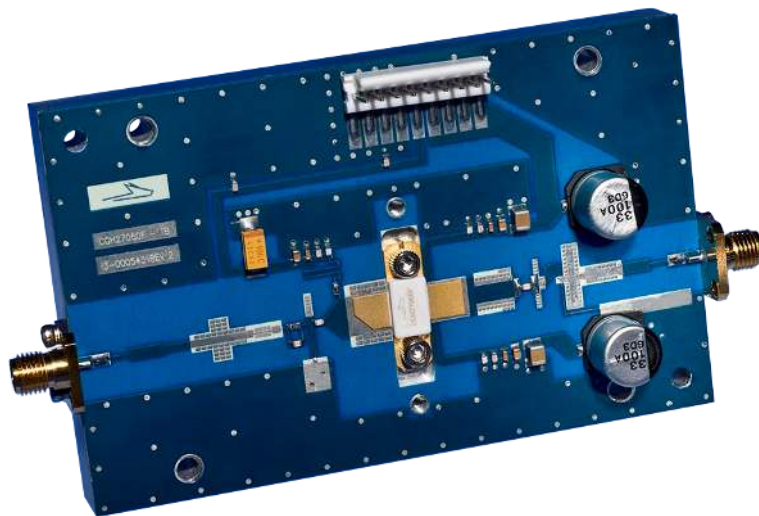
Note: Area exceeds Maximum Case Operating Temperature (See Page 2)



## CGH27060F-AMP Demonstration Amplifier Circuit Bill of Materials

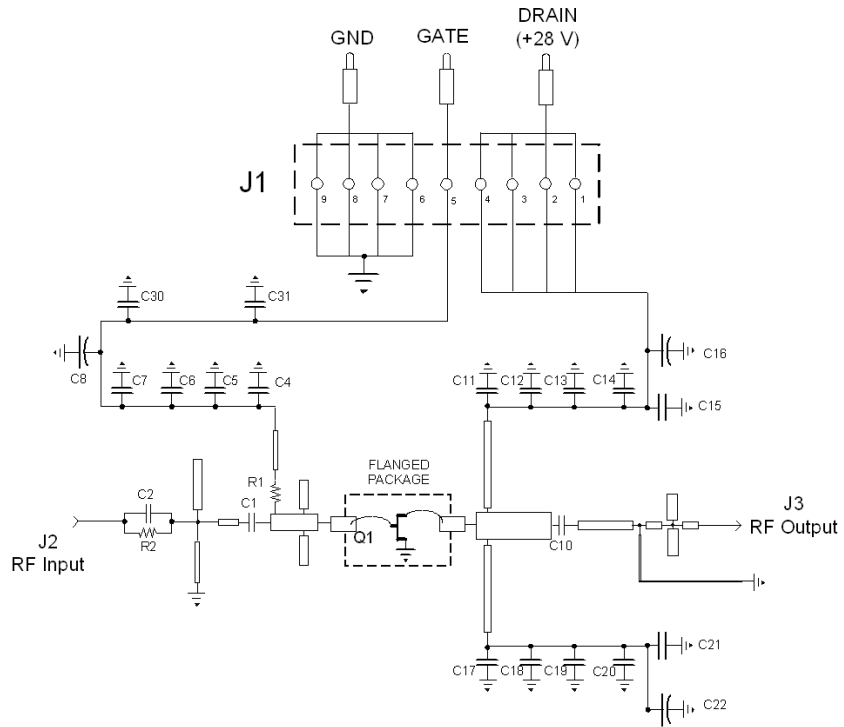
Designator	Description	Qty
R1	RES, 1/16W, 0603, 1%, 5.1 OHMS	1
R2	RES, 1/16W, 0603, 1%, 100 OHMS	1
C6, C13, C19	CAP, 470pF, 10%, 100V, 0603	3
C16, C22	CAP, 33μF, 20%, G CASE	1
C15, C21	CAP, 1.0μF, 100V, 10%, X7R, 1210	1
C8	CAP 10μF 16V TANTALUM	1
C10	CAP, 8.2pF, +/-5%, 100B	1
C1	CAP, 0.9pF, +/-0.05pF, 0603	1
C2	CAP, 2.2pF, +/-0.1pF, 0603	1
C10, C11, C17	CAP, 10.0pF, +/-5%, 0603	3
C5, C12, C18, C30, C31	CAP, 82pF, +/-5%, 0603	5
C7, C14, C20	CAP, 33000pF, 0805, 100V, X7R	3
J2, J3	CONN SMA STR PANEL JACK RECP	1
J1	HEADER RT>PLZ .1CEN LK 9POS	1
-	PCB, RO4350B, Er = 3.48, h = 20 mil	1
-	CGH27060F	1

## CGH27060F-AMP Demonstration Amplifier Circuit

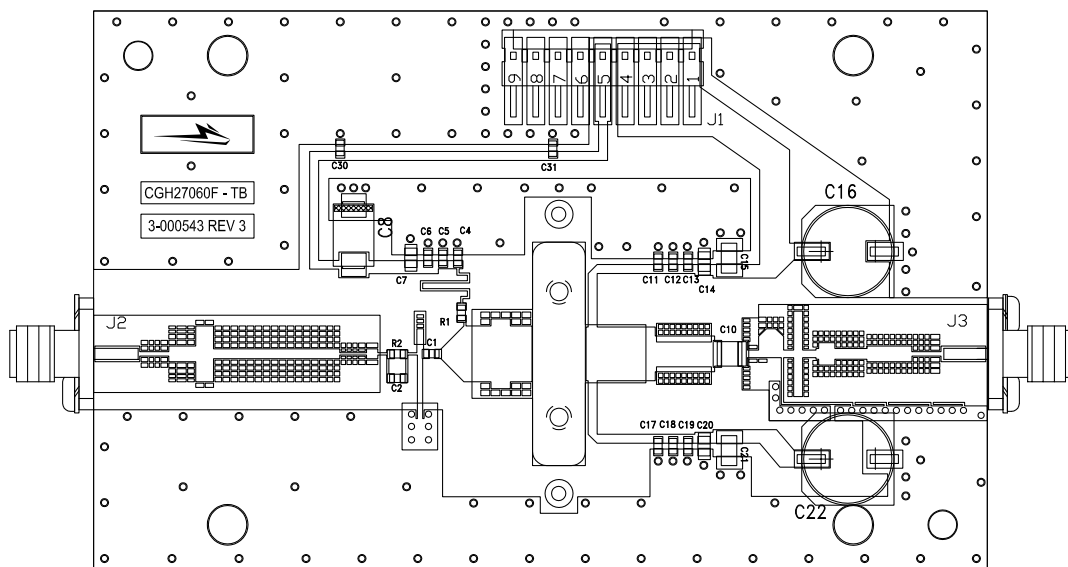




### CGH27060F-AMP Demonstration Amplifier Circuit Schematic



### CGH27060F-AMP Demonstration Amplifier Circuit Outline







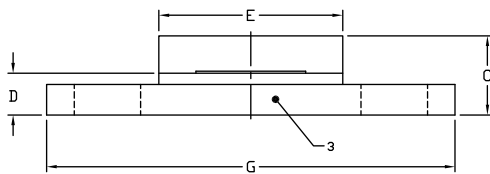
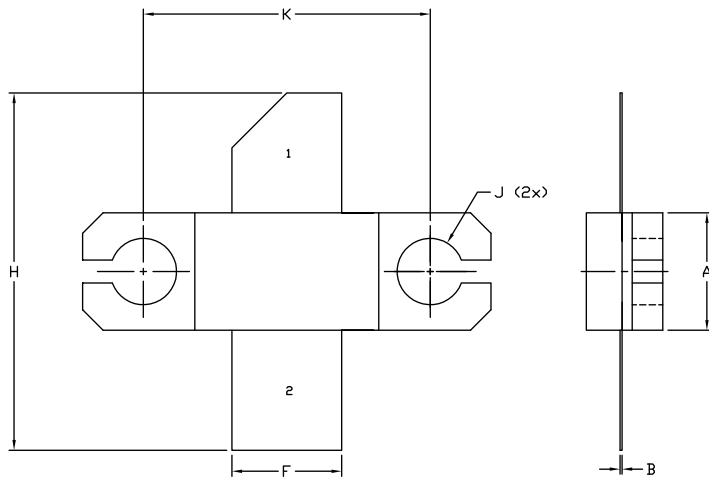
**Typical Package S-Parameters for CGH27060F**  
**(Small Signal,  $V_{DS} = 28$  V,  $I_{DQ} = 300$  mA, angle in degrees)**

Frequency	Mag S11	Ang S11	Mag S21	Ang S21	Mag S12	Ang S12	Mag S22	Ang S22
500 MHz	0.935	-171.10	7.31	80.30	0.013	-4.81	0.629	-171.50
600 MHz	0.935	-173.48	6.08	76.43	0.013	-7.68	0.635	-171.81
700 MHz	0.936	-175.34	5.20	72.85	0.013	-10.25	0.642	-171.96
800 MHz	0.937	-176.87	4.54	69.47	0.013	-12.62	0.649	-172.04
900 MHz	0.937	-178.19	4.03	66.24	0.013	-14.82	0.656	-172.11
1.0 GHz	0.938	-179.38	3.62	63.13	0.013	-16.89	0.664	-172.18
1.1 GHz	0.939	-179.54	3.28	60.12	0.013	-18.84	0.672	-172.28
1.2 GHz	0.939	-178.52	3.00	57.20	0.012	-20.69	0.680	-172.42
1.3 GHz	0.940	-177.55	2.77	54.36	0.012	-22.44	0.688	-172.60
1.4 GHz	0.941	-176.60	2.57	51.59	0.012	-24.10	0.695	-172.83
1.5 GHz	0.942	-175.68	2.39	48.89	0.012	-25.67	0.703	-173.11
1.6 GHz	0.942	-174.77	2.24	46.24	0.012	-27.15	0.710	-173.42
1.7 GHz	0.943	-173.87	2.11	43.66	0.012	-28.56	0.718	-173.78
1.8 GHz	0.943	-172.96	2.00	41.12	0.011	-29.88	0.724	-174.18
1.9 GHz	0.944	-172.04	1.90	38.63	0.011	-31.12	0.731	-174.61
2.0 GHz	0.944	-171.11	1.81	36.19	0.011	-32.29	0.737	-175.07
2.1 GHz	0.944	-170.16	1.73	33.78	0.011	-33.39	0.743	-175.57
2.2 GHz	0.944	-169.19	1.67	31.41	0.011	-34.42	0.748	-176.10
2.3 GHz	0.945	-168.19	1.61	29.06	0.011	-35.38	0.753	-176.65
2.4 GHz	0.944	-167.16	1.55	26.74	0.010	-36.28	0.758	-177.23
2.5 GHz	0.944	-166.10	1.51	24.43	0.010	-37.11	0.762	-177.83
2.6 GHz	0.944	-165.00	1.47	22.14	0.010	-37.88	0.765	-178.45
2.7 GHz	0.944	-163.85	1.43	19.85	0.010	-38.60	0.769	-179.10
2.8 GHz	0.943	-162.64	1.41	17.56	0.010	-39.27	0.771	-179.77
2.9 GHz	0.942	-161.38	1.38	15.27	0.010	-39.90	0.774	-179.54
3.0 GHz	0.941	-160.06	1.36	12.96	0.010	-40.48	0.776	-178.82
3.2 GHz	0.939	-157.18	1.34	8.27	0.010	-41.54	0.778	-177.32
3.4 GHz	0.935	-153.93	1.33	3.43	0.010	-42.52	0.779	-175.73
3.6 GHz	0.931	-150.21	1.34	-1.65	0.010	-43.50	0.778	-174.01
3.8 GHz	0.925	-145.88	1.37	-7.06	0.010	-44.60	0.774	-172.17
4.0 GHz	0.916	-140.74	1.43	-12.95	0.011	-45.95	0.769	-170.17
4.2 GHz	0.906	-134.55	1.50	-19.47	0.011	-47.77	0.760	-167.98
4.4 GHz	0.891	-126.90	1.61	-26.85	0.012	-50.32	0.749	-165.56
4.6 GHz	0.872	-117.26	1.75	-35.39	0.013	-53.96	0.733	-162.84
4.8 GHz	0.848	-104.85	1.92	-45.48	0.014	-59.15	0.713	-159.74
5.0 GHz	0.817	-88.57	2.14	-57.60	0.016	-66.44	0.688	-156.11
5.2 GHz	0.784	-67.16	2.37	-72.25	0.018	-76.37	0.654	-151.74
5.4 GHz	0.759	-39.85	2.58	-89.71	0.020	-89.30	0.609	-146.35
5.6 GHz	0.757	-8.00	2.70	-109.65	0.021	-104.92	0.546	-139.55
5.8 GHz	0.788	-24.14	2.67	-130.98	0.022	-122.14	0.460	-130.98
6.0 GHz	0.836	-52.18	2.49	-152.33	0.021	-139.60	0.347	-119.94

To download the s-parameters in s2p format, go to the [CGH27060F Product Page](#) and click on the documentation tab.



**Product Dimensions CGH27060F (Package Type — 440193)**



**NOTES:**

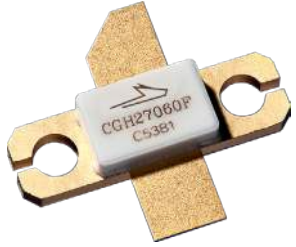

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
5. ALL PLATED SURFACES ARE Ni/AU

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.225	0.235	5.72	5.97
B	0.004	0.006	0.10	0.15
C	0.145	0.165	3.68	4.19
D	0.077	0.087	1.96	2.21
E	0.355	0.365	9.02	9.27
F	0.210	0.220	5.33	5.59
G	0.795	0.805	20.19	20.45
H	0.670	0.730	17.02	18.54
J	∅ .130		3.30	
k	0.562		14.28	

- PIN 1. GATE  
 PIN 2. DRAIN  
 PIN 3. SOURCE



**Product Ordering Information**

Order Number	Description	Unit of Measure	Image
CGH27060F	GaN HEMT	Each	 A photograph of a GaN HEMT component. It consists of a small, rectangular, light-colored chip mounted on a gold-colored metal carrier. The carrier has two circular holes on the left side and a central slot. The chip is labeled with "CGH27060F" and "C5381" and has a small arrow pointing to the right.
CGH27060F-AMP	Test board with GaN HEMT installed	Each	 A photograph of a blue printed circuit board (PCB) populated with various electronic components. A central component is the GaN HEMT chip, which is mounted on a small carrier. The board includes several surface-mount components, including capacitors and resistors, and has two SMA connectors on the right side.

**For more information, please contact:**

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## Notes & Disclaimer

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